

# **AC7912A Datasheet**

**Zhuhai Jieli Technology Co.,LTD**

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## AC7912A Features

### High performance 32-bit RISC CPU

- Double core RISC 32-bit CPU(Support FPU)
- 24KB D-Cache 6 way, 32KB I-Cache 8way
- DC-320MHz operation
- 128 Vectored interrupts
- Four Levels interrupt priority

### Image Signal Processor

- Support DVP and BT656 interface timing
- Support YUV422 format (Input)
- Support YUV422 and YUV420 format (Output)
- Support 720p@30fps input size

### Flexible I/O

- 45 GPIO pins
- All GPIO pins can be programmable as input or output individually
- All GPIO pins are internal pull-up/pull-down selectable individually
- CMOS/TTL level Schmitt triggered input
- External wake up/interrupt on all GPIOs

### Peripheral Feature

- FUSB 1.1/HUSB2.0 OTG controller
- Audio interface supports IIS, left adjusted, right adjusted and DSP mode
- Multi-function 32-bit timers, support capture and PWM mode
- 16-bit PWM generator for motor driving
- 16-bit active parallel port
- Three full-duplex advanced UART
- Three SPI interface supports host and device mode
- Two SD Card Host controller
- One IIC interface supports host and device mode
- One SPDIF receiving interface without analog amplify

- Quadrate decoder
- Watchdog
- Two Crystal Oscillator
- Two channel 16-bit DAC with headphone amplifier
- Two channels Audio 16-bit ADC
- Four channels MIC amplifier
- Four channels analog MUX
- Fourteen channels 10-bit ADC
- Power-on reset
- Embedded PMU support low power mode

### Bluetooth Feature

- CMOS single-chip fully-integrated radio and baseband
- Compliant with Bluetooth V2.1(BR+EDR)+ BLE V5.3 specification
- Bluetooth Piconet and Scatternet support
- Meet class2 and class3 transmitting power requirement
- Support GFSK and  $\pi/4$  DQPSK all packet types
- Provides 18dbm+ transmitting power
- Receiver with -89dBm sensitivity at least
- Support a2dp\avctp\avdtp\avrcp\hfp\spp\smp \att\gap\gatt\rfcomm\sdp\l2cap profile

### WIFI Feature

- Support all mandatory IEEE 802.11b data rates of 1, 2, 5.5 and 11 Mbps, all 802.11g payload data rates of 6, 9, 12, 18, 24, 36, 48 and 54 Mbps, as well as 802.11n MCS0~MCS7, MCS32, 20MHz/40MHz BW, 800ns and 400ns guard interval.
- Support advanced 1x1 802.11n features:
  - Full / Half Guard Interval
  - Frame Aggregation
  - Reduced Inter-frame Space (RIFS)
  - Space Time Block Coding (STBC)
  - Greenfield mode

- Support WEP/WPA-PSK(TKIP/CCMP)  
/WPA2-PSCK/AES256/AES128/SHA256  
/SHA128

- Support apply to AP/STA

- Transmitter power:

DSSS 1M/S	19	dBm
MCS0	19	dBm
MCS7	14	dBm

- Receiver sensitivity:

DSSS 1M/S	-97	dBm
MCS0	-92.5	dBm
MCS7	-74	dBm

### Packages

- QFN68(7mm\*7mm)

### Temperature

- Operating temperature: -40°C to +85°C
- Storage temperature: -65°C to +150°C

# 1. Pin Definition

## 1.1 Pin Assignment

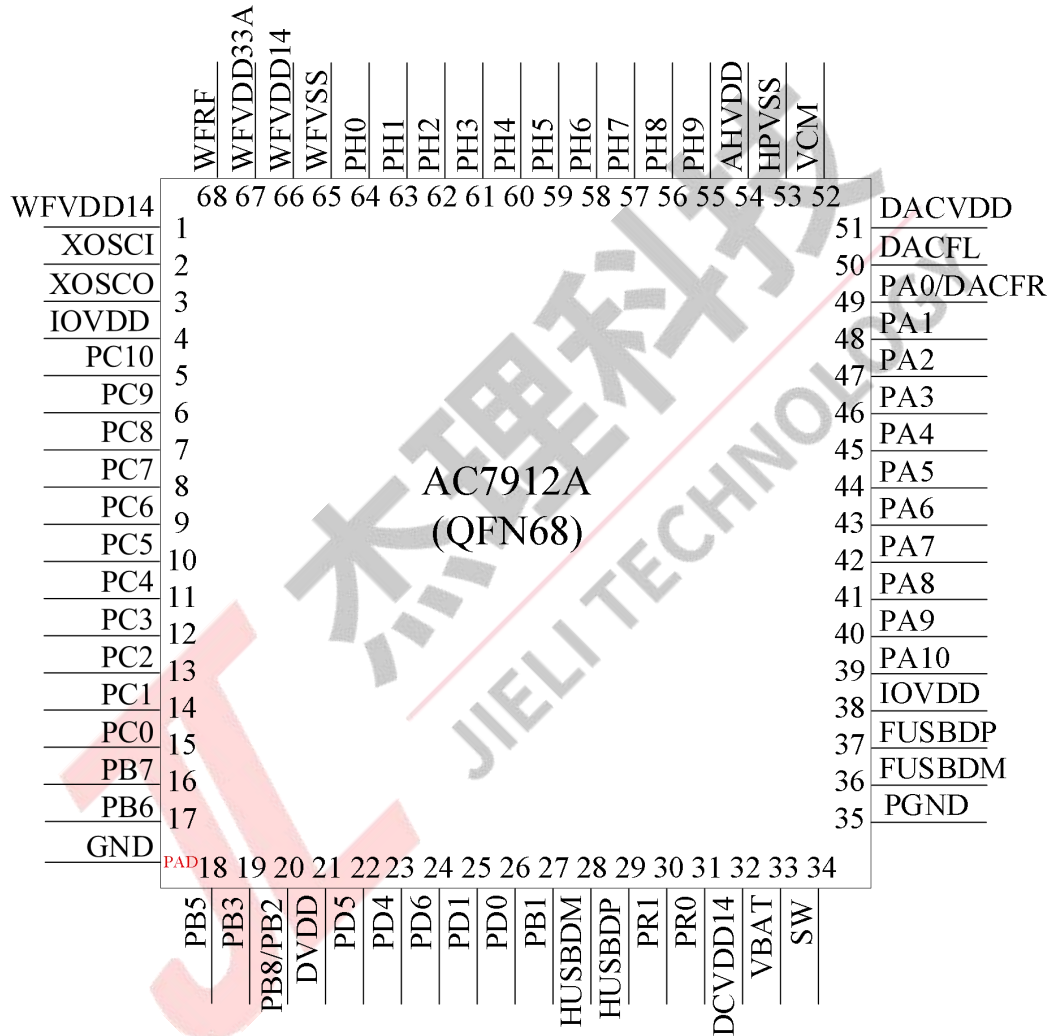


Figure 1-1 AC7912A\_QFN68 Package Diagram

## 1.2 Pin Description

Table 1-1 AC7912A\_QFN68 Pin Description

PIN NO.	Name	I/O Type	Drive (mA)	Function	Other Function
1	WVDD14	P	/	RF Power 1.4V	-
2	XOSCI	I	/	RF OSCI	-
3	XOSCO	O	/	RF OSCO	-
4	IOVDD	P	/	IO Power 3.3V	-
5	PC10	I/O	24/16/8/2.4	GPIO	LCD_SYNC1_B: LCD Synchronization1(B) SENSOR0_SYNC1_B: Sensor0 Synchronization1(B) SENSOR1_SYNC1_A: Sensor1 Synchronization1(A) SD0_CLKD: SD0 Clock(D) EMI_WR: EMI Write PAP_RD_A: PAP Read(A) SPI1_DOB: SPI1 Data Out(B) ISP_DI_B Q-decoder1 UART2_RXB: Uart2 Data In(B) ADC9: ADC Channel 9 TMR5CK(MCPWM) PWM3: Timer3 PWM Output TOUCH10: Touch Input Channel 10 SDTAP_DATA
6	PC9	I/O	24/16/8/2.4	GPIO	LCD_SYNC0_B: LCD Synchronization0(B) SENSOR0_SYNC0_B: Sensor0 Synchronization0(B) SENSOR1_SYNC0_A: Sensor1 Synchronization0(A) SD0_CMDD: SD0 CMD(D) PAP_WR_A: PAP Write(A) SPI1_CLKB: SPI1 Clock(B) ISP_CLK_B Q-decoder0 UART2_TXB: Uart2 Data Out(B) ADC8: ADC Channel 8 TMR4CK(MCPWM) TOUCH9: Touch Input Channel 9 SDTAP_CLKA

PIN NO.	Name	I/O Type	Drive (mA)	Function	Other Function
7	PC8	I/O	24/16/8/2.4	GPIO	LCD_CLK_B: LCD Clock(B) SENSOR0_CLK_B: Sensor0 Clock(B) SENSOR1_CLK_A: Sensor1 Clock(A) SD0_DAT0D: SD0 Data0(D) EMI_D7: EMI Data7 PAP_D15_A: PAP Data15(A) SPI1_DIB: SPI1 Data In(B) SPDIF_B PWMCH2L(MCPWM) CAP5: Timer5 Capture TOUCH8: Touch Input Channel 8
8	PC7	I/O	24/16/8/2.4	GPIO	LCD_D0_B: LCD Data0(B) SENSOR0_D7_B: Sensor0 Data7(B) SENSOR1_D0_A: Sensor1 Data0(A) SD0_DAT1D: SD0 Data1(D) EMI_D6: EMI Data6 PAP_D14_A: PAP Data14(A) SPDIF_A PWMCH2H(MCPWM) CAP4: Timer4 Capture TOUCH7: Touch Input Channel 7
9	PC6	I/O	24/16/8/2.4	GPIO	LCD_D1_B: LCD Data1(B) SENSOR0_D6_B: Sensor0 Data6(B) SENSOR1_D1_A: Sensor1 Data1(A) SD0_DAT2D: SD0 Data2(D) EMI_D5: EMI Data5 PAP_D13_A: PAP Data13(A) ALNK0_DAT3A: Audio Link0 Data3(A) ALNK1_DAT3A: Audio Link1 Data3(A) TMR3CK(MCPWM) PWM5: Timer5 PWM Output TOUCH6: Touch Input Channel 6
10	PC5	I/O	24/16/8/2.4	GPIO	LCD_D2_B: LCD Data2(B) SENSOR0_D5_B: Sensor0 Data5(B) SENSOR1_D2_A: Sensor1 Data2(A) SD0_DAT3D: SD0 Data3(D) EMI_D4: EMI Data4 PAP_D12_A: PAP Data12(A) ALNK0_DAT2A: Audio Link0 Data2(A) ALNK1_DAT2A: Audio Link1 Data2(A) SPI0_CSB: SPI0 Chip Select(B) SD1_DAT3B: SD1 Data3(B) TMR2CK(MCPWM) PWM4: Timer4 PWM Output TOUCH5: Touch Input Channel 5

PIN NO.	Name	I/O Type	Drive (mA)	Function	Other Function
11	PC4	I/O	24/16/8/2.4	GPIO	LCD_D3_B: LCD Data3(B) SENSOR0_D4_B: Sensor0 Data4(B) SENSOR1_D3_A: Sensor1 Data3(A) UART1_RXB: Uart1 Data In(B) EMI_D3: EMI Data3 PAP_D11_A: PAP Data11(A) ALNK0_DAT1A: Audio Link0 Data1(A) ALNK1_DAT1A: Audio Link1 Data1(A) SPI0_D0B(0): SPI0 Data Out(B) SD1_DAT2B: SD1 Data2(B) FPIN7(MCPWM) TMR5: Timer5 Clock In TOUCH4: Touch Input Channel 4
12	PC3	I/O	24/16/8/2.4	GPIO	LCD_D4_B: LCD Data4(B) SENSOR0_D3_B: Sensor0 Data3(B) SENSOR1_D4_A: Sensor1 Data4(A) UART1_TXB: Uart1 Data Out(B) EMI_D2: EMI Data2 PAP_D10_A: PAP Data10(A) ALNK0_DAT0A: Audio Link0 Data0(A) ALNK1_DAT0A: Audio Link1 Data0(A) SPI0_CLKB: SPI0 Clock(B) SD1_DAT1B: SD1 Data1(B) FPIN6(MCPWM) TMR4: Timer4 Clock In TOUCH3: Touch Input Channel 3
13	PC2	I/O	24/16/8/2.4	GPIO	LCD_D5_B: LCD Data5(B) SENSOR0_D2_B: Sensor0 Data2(B) SENSOR1_D5_A: Sensor1 Data5(A) IIC_SDA_C: IIC SDA(C) EMI_D1: EMI Data1 PAP_D9_A: PAP Data9(A) ALNK0_LRCKA: Audio Link0 Word Select(A) ALNK1_LRCKA: Audio Link1 Word Select(A) SPI0_DAT3B(3): SPI0 Data3 In(B) SD1_DAT0B: SD1 Data0(B) PWMCH4L(MCPWM) CAP1: Timer1 Capture TOUCH2: Touch Input Channel 2

PIN NO.	Name	I/O Type	Drive (mA)	Function	Other Function
14	PC1	I/O	24/16/8/2.4	GPIO	LCD_D6_B: LCD Data6(B) SENSOR0_D1_B: Sensor0 Data1(B) SENSOR1_D6_A: Sensor1 Data6(A) IIC_SCL_C: IIC SCL(C) EMI_D0: EMI Data0 PAP_D8_A: PAP Data8(A) ALNK0_SCLKA: Audio Link0 Serial Clock(A) ALNK1_SCLKA: Audio Link1 Serial Clock(A) SPI0_DAT2B(2): SPI0 Data2 In(B) SD1_CLKB: SD1 Clock(B) ADC7: ADC Channel 7 PWM1: Timer1 PWM Output Wakeup11: Port Wakeup 11 TOUCH1: Touch Input Channel 1
15	PC0	I/O	24/16/8/2.4	GPIO	LCD_D7_B: LCD Data7(B) SENSOR0_D0_B: Sensor0 Data0(B) SENSOR1_D7_A: Sensor1 Data7(A) CLKOUT0: Clock Out0 PAP_RD_B: PAP Read(B) ALNK0_MCKA: Audio Link0 Master Clock(A) ALNK1_MCKA: Audio Link1 Master Clock(A) SPI0_DIB(1): SPI0 Data In(B) SD1_CMDB: SD1 CMD(B) ADC6: ADC Channel 6 PWMCH4H(MCPWM) Wakeup10: Port Wakeup 10 TOUCH0: Touch Input Channel 0
16	PB7	I/O	24/16/8/2.4	GPIO	UART1_RTS:Uart1 Receive Bit Stream Control SPI1_DOA: SPI1 Data Out(A) UART2_RXC: Uart2 Data In(C) ADC5: ADC Channel 5 PWMCH7L(MCPWM) SDTAP_DATC



PIN NO.	Name	I/O Type	Drive (mA)	Function	Other Function
17	PB6	I/O	24/16/8/2.4	GPIO	UART1_CTS: Uart1 Transmit Bit Stream Control SPI1_CLKA: SPI1 Clock(A) UART2_TXC: Uart2 Data Out(C) ADC4: ADC Channel 4 PWMCH7H(MCPWM) Wakeup9: Port Wakeup 9 SDTAP_CLKC
18	PB5	I/O	8	GPIO	PLNK0_DAT1: PLNK0 Data1 PLNK1_DAT1: PLNK1 Data1 SPI1_DIA: SPI1 Data In(A) FPIN2(MCPWM) CAP0: Timer0 Capture
19	PB3	I/O	8	GPIO	PLNK0_SCLK: PLNK0 Serial Clock UART1_TXC: Uart1 Data Out(C) PWMCH6L(MCPWM)
20	PB2	I/O	8	GPIO	PLNK0_DAT0: PLNK0 Data0 PLNK1_DAT0: PLNK1 Data0 UART0_RXB: Uart0 Data In(B) PWMCH6H(MCPWM) CAP2: Timer2 Capture
	PB8	I/O	24/16/8/2.4	GPIO	SDGAT: SD Power Gate
21	DVDD	P	/	Core Power 1.2V	-
22	PD5	I/O	24/16/8/2.4	GPIO	SPI0_DOA(0): SPI0 Data Out(A) SFC_DOA(0): SFC Data Out(A)
23	PD4	I/O	24/16/8/2.4	GPIO	SPI0_CLKA: SPI0 Clock(A) SFC_CLKA: SFC Clock(A)
24	PD6	I/O	24/16/8/2.4	GPIO	SFGAT: Flash Power Gate
25	PD1	I/O	24/16/8/2.4	GPIO	SPI0_DIA(1): SPI0 Data In(A) SFC_DIA(1): SFC Data In(A)
26	PD0	I/O	24/16/8/2.4	GPIO (pull up)	SPI0_CSA: SPI0 Chip Select(A) SFC_CSA: SFC Chip Select(A)
27	PB1	I/O	24/16/8/2.4	GPIO (pull up)	ISP_DO UART0_TXB: Uart0 Data Out(B) ADC3: ADC Channel 3 Long Press reset TMR1: Timer1 Clock In Wakeup8: Port Wakeup 8
28	HUSBDM	I/O	10	USB Negative Data	-
29	HUSBDP	I/O	10	USB Positive Data	-
30	PR1	I/O	16/2.4	GPIO	OSC32KO

PIN NO.	Name	I/O Type	Drive (mA)	Function	Other Function
31	PR0	I/O	16/2.4	GPIO	OSC32KI
32	DCVDD14	P	/	Core Power 1.4V	-
33	VBAT	P	/	LDO Power	-
34	SW	P	/	DC-DC Switch Pin	-
35	PGND	P	/	PMU Ground	-
36	FUSBDM	I/O	10	USB Negative Data (pull down)	UART1_RXD: Uart1 Data In(D) ISP_DI_A SPI2_D0B: SPI2 Data Out(B) IIC_SDA_A: IIC SDA(A) ADC12: ADC Channel 12 SDTAP_DATB
37	FUSBDP	I/O	10	USB Positive Data (pull down)	UART1_TXD: Uart1 Data Out(D) ISP_CLK_A SPI2_CLKB: SPI2 Clock(B) IIC_SCL_A: IIC SCL(A) ADC13: ADC Channel 13 SDTAP_CLKB
38	IOVDD	P	/	IO Power 3.3V	-
39	PA10	I/O	24/16/8/2.4	GPIO	LCD_SYNC1_A: LCD Synchronization1(A) SENSOR0_SYNC1_A: Sensor0 Synchronization1(A) SD0_DAT1B: SD0 Data1(B) ALNK0_DAT3B1: Audio Link0 Data3(B1) ALNK1_DAT3B1: Audio Link1 Data3(B1) ADC2: ADC Channel 2 TMR7CK(MCPWM)
40	PA9	I/O	24/16/8/2.4	GPIO	LCD_SYNC0_A: LCD Synchronization0(A) SENSOR0_SYNC0_A: Sensor0 Synchronization0(A) SD0_DAT0B: SD0 Data0(B) ALNK0_DAT2B1: Audio Link0 Data2(B1) ALNK1_DAT2B1: Audio Link1 Data2(B1) TMR6CK(MCPWM)

PIN NO.	Name	I/O Type	Drive (mA)	Function	Other Function
41	PA8	I/O	24/16/8/2.4	GPIO	LCD_CLK_A: LCD Clock(A) SENSOR0_CLK_A: Sensor0 Clock(A) IIC_SDA_B: IIC SDA(B) SD0_CLKB: SD0 Clock(B) ALNK0_DAT1B1: Audio Link0 Data1(B1) ALNK1_DAT1B1: Audio Link1 Data1(B1) SPDIF_D ADC1: ADC Channel 1 PWMCH1L(MCPWM) Wakeup4: Port Wakeup 4 SDTAP_DATD
42	PA7	I/O	24/16/8/2.4	GPIO	LCD_D0_A: LCD Data0(A) SENSOR0_D7_A: Sensor0 Data7(A) IIC_SCL_B: IIC SCL(B) SD0_CMDB: SD0 CMD(B) ALNK0_DAT0B1: Audio Link0 Data0(B1) ALNK1_DAT0B1: Audio Link1 Data0(B1) SPDIF_C ADC0: ADC Channel 0 PWMCH1H(MCPWM) TMR0: Timer0 Clock In Wakeup3: Port Wakeup 3 SDTAP_CLKD
43	PA6	I/O	24/16/8/2.4	GPIO	LCD_D1_A: LCD Data1(A) SENSOR0_D6_A: Sensor0 Data6(A) UART0_RXA: Uart0 Data In(A) SD0_DAT3B: SD0 Data3(B) ALNK0_LRCKB1: Audio Link0 Word Select (B1) ALNK1_LRCKB1: Audio Link1 Word Select(B1) FPIN0(MCPWM)
44	PA5	I/O	24/16/8/2.4	GPIO	LCD_D2_A: LCD Data2(A) SENSOR0_D5_A: Sensor0 Data5(A) UART0_TXA: Uart0 Data Out(A) SD0_DAT2B: SD0 Data2(B) AMUX2: Simulator Channel 2 ALNK0_SCLKB1: Audio Link0 Serial Clock(B1) ALNK1_SCLKB1: Audio Link1 Serial Clock(B1) CAP3: Timer3 Capture

PIN NO.	Name	I/O Type	Drive (mA)	Function	Other Function
45	PA4	I/O	24/16/8/2.4	GPIO	LCD_D3_A: LCD Data3(A) SENSOR0_D4_A: Sensor0 Data4(A) CLKOUT1: Clock Out1 SPI2_DOC: SPI2 Data Out(C) MIC2N: MIC2 N Channel ALNK0_MCKB1: Audio Link0 Master Clock(B1) ALNK1_MCKB1: Audio Link1 Master Clock(B1) UART0_RXC: Uart0 Data In(C) PWMCH0L(MCPWM)
46	PA3	I/O	24/16/8/2.4	GPIO	LCD_D4_A: LCD Data4(A) SENSOR0_D3_A: Sensor0 Data3(A) SPI2_CLKC: SPI2 Clock(C) MIC2P: MIC2 P Channel UART0_TXC: Uart0 Data Out(C) PWMCH0H(MCPWM)
47	PA2	I/O	24/16/8/2.4	GPIO	LCD_D5_A: LCD Data5(A) SENSOR0_D2_A: Sensor0 Data2(A) SPI2_DIC: SPI2 Data In(C) MIC0P: MIC0 P Channel TMR0CK(MCPWM)
48	PA1	I/O	24/16/8/2.4	GPIO	LCD_D6_A: LCD Data6(A) SENSOR0_D1_A: Sensor0 Data1(A) MIC0N: MIC0 N Channel PWM0: Timer0 PWM Output
49	PA0	I/O	24/16/8/2.4	GPIO	LCD_D7_A: LCD Data7(A) SENSOR0_D0_A: Sensor0 Data0(A) AMUX0: Simulator Channel 0 TMR1CK(MCPWM) Wakeup2: Port Wakeup 2
	DACFR	O	/	DAC Right Channel	-
50	DACFL	O	/	DAC Left Channel	-
51	DACVDD	P	/	DAC Power	-
52	VCM	P	/	VCM	-
53	HPVSS	P	/	Audio Ground	-
54	AHVDD	P	/	Audio Power	-
55	PH9	I/O	24/16/8/2.4	GPIO	MIC1P: MIC1 P Channel
56	PH8	I/O	24/16/8/2.4	GPIO	MIC1N: MIC1 N Channel

PIN NO.	Name	I/O Type	Drive (mA)	Function	Other Function
57	PH7	I/O	24/16/8/2.4	GPIO	AMUX1: Simulator Channel 1 UART1_RXA: Uart1 Data In(A) EMI_D23: EMI Data23 PAP_D7_AB: PAP Data7(AB) SD1_CLKA: SD1 Clock(A) PWMCH5L(MCPWM) Wakeup13: Port Wakeup 13
58	PH6	I/O	24/16/8/2.4	GPIO	MIC3P: MIC3 P Channel SENSOR1_D2_B: Sensor1 Data2(B) UART1_TXA: Uart1 Data Out(A) EMI_D22: EMI Data22 PAP_D6_AB: PAP Data6(AB) SD1_CMDA: SD1 CMD(A) FPIN3(MCPWM) PWM2: Timer2 PWM Output
59	PH5	I/O	24/16/8/2.4	GPIO	MIC3N: MIC3 N Channel SENSOR1_D3_B: Sensor1 Data3(B) SD0_DAT3C: SD0 Data3(C) EMI_D21: EMI Data21 PAP_D5_AB: PAP Data5(AB) SD1_DAT0A: SD1 Data0(A) FPIN5(MCPWM)
60	PH4	I/O	24/16/8/2.4	GPIO	AMUX3: Simulator Channel 3 SENSOR1_CLK_B: Sensor1 Clock(B) SD0_DAT2C: SD0 Data2(C) EMI_D20: EMI Data20 PAP_D4_AB: PAP Data4(AB) SD1_DAT1A: SD1 Data1(A) FPIN4(MCPWM)
61	PH3	I/O	24/16/8/2.4	GPIO	LCD_SYNC2_A/B: LCD Synchronization2(A/B) SENSOR1_D0_B: Sensor1 Data0(B) SD0_DAT1C: SD0 Data1(C) EMI_D19: EMI Data19 PAP_D3_AB: PAP Data3(AB) UART2_RXA: Uart2 Data In(A) SD1_DAT2A: SD1 Data2(A) ADC11: ADC Channel 11 PWMCH5H(MCPWM) TOUCH14: Touch Input Channel 14

PIN NO.	Name	I/O Type	Drive (mA)	Function	Other Function
62	PH2	I/O	24/16/8/2.4	GPIO	SENSOR1_D1_B: Sensor1 Data1(B) SD0_CLKC: SD0 Clock(C) EMI_D18: EMI Data18 PAP_D2_AB: PAP Data2(AB) SPI2_DIA: SPI2 Data In(A) UART2_TXA: Uart2 Data Out(A) SD1_DAT3A: SD1 Data3(A) TOUCH13: Touch Input Channel 13
63	PH1	I/O	24/16/8/2.4	GPIO	IIC_SDA_D: IIC SDA(D) SENSOR1_SYNC1_B: Sensor1 Synchronization1(B) SD0_CMDC: SD0 CMD(C) EMI_D17: EMI Data17 PAP_D1_AB: PAP Data1(AB) SPI2_DOA: SPI2 Data Out(A) UART0_RXD: Uart0 Data In(D) PWMCH3L(MCPWM) TOUCH12: Touch Input Channel 12
64	PH0	I/O	24/16/8/2.4	GPIO	IIC_SCL_D: IIC SCL(D) SENSOR1_SYNC0_B: Sensor1 Synchronization0(B) SD0_DAT0C: SD0 Data0(C) EMI_D16: EMI Data16 PAP_D0_AB: PAP Data0(AB) SPI2_CLKA: SPI2 Clock(A) UART0_TXD: Uart0 Data Out(D) ADC10: ADC Channel 10 PWMCH3H(MCPWM) Wakeup12: Port Wakeup 12 TOUCH11: Touch Input Channel 11
65	WVSS	P	/	WIFI Ground	
66	WVDD14	P	/	RF Power 1.4V	-
67	WVDD33A	P	/	RF Power 3.3V	-
68	WFRF	-	/	RF Antenna	-
PAD		P	/	VSS	-

## 2. Electrical Characteristics

### 2.1 Absolute Maximum Ratings

Table 2-1

Symbol	Parameter	Min	Max	Unit
Tamb	Ambient Temperature	-40	+85	°C
Tstg	Storage temperature	-65	+150	°C
VBAT	Supply Voltage	-0.3	5.5	V
WVDD33A	RF Power 3.3V Voltage	-0.3	3.5	V
AHVDD	Audio Power Voltage	-0.3	3.5	V
WVDD14	RF Power 1.4V Voltage	-0.3	1.55	V
V <sub>3.3IO</sub>	3.3V IO Input Voltage	-0.3	IOVDD+0.3	V

### 2.2 PMU Characteristics

Table 2-2

Symbol	Parameter	Min	Typ	Max	Unit	Test Conditions
VBAT	Voltage Input	2.2	3.7	5.5	V	—
IOVDD	Voltage output	2.1	3.3	3.5	V	LDO5V = 5V, 200mA loading
DCVDD14	Voltage output	1.2	1.4	1.55	V	LDO mode: 70mA loading DC-DC mode: 120mA loading
DVDD	Voltage output	0.87	1.2	1.32	V	LDO5V=5V, 100mA loading
WVDD33A	Voltage Input	2.1	3.3	3.5	V	—
AHVDD	Voltage Input	2.1	3.3	3.5	V	—
WVDD14	Voltage Input	1.2	1.4	1.55	V	—

## 2.3 IO Input/Output Electrical Logical Characteristics

Table 2-3

IO input characteristics						
Symbol	Parameter	Min	Typ	Max	Unit	Test Conditions
V <sub>IL</sub>	Low-Level Input Voltage	-0.3	—	0.3* IOVDD	V	IOVDD = 3.3V
V <sub>IH</sub>	High-Level Input Voltage	0.7* IOVDD	—	IOVDD+0.3	V	IOVDD = 3.3V
IO output characteristics						
V <sub>OL</sub>	Low-Level Output Voltage	—	—	0.33	V	IOVDD = 3.3V
V <sub>OH</sub>	High-Level Output Voltage	2.7	—	—	V	IOVDD = 3.3V

## 2.4 Internal Resistor Characteristics

Table 2-4

Port	General Output	High Drive	Internal Pull-Up Resistor	Internal Pull-Down Resistor	Comment
PA,PC,PH PD0-PD1 PD4-PD6 PB1,PB6-PB8	8mA	24mA	10K	10K	1.PB1&PD0 default pull up 2.FUSBDM & FUSBDP default pull down 3. Internal pull-up/pull-down resistance   accuracy ±20%
PB2,PB3,PB5	8mA	—	10K	10K	
PR0,PR1	2.4mA	16mA	10K	10K	
FUSBDP FUSBDM	10mA	—	1.5K	15K	



## 2.5 DAC Characteristics

Table 2-5

Parameter	Min	Typ	Max	Unit	Test Conditions
Frequency Response	20	—	20K	Hz	1KHz/0dB 10Kohm loading With A-Weighted Filter
THD+N	—	-72	—	dB	
S/N	—	99	—	dB	
Crosstalk	—	-90	—	dB	
Output Swing	—	0.9	—	Vrms	1KHz/-60dB 10Kohm loading With A-Weighted Filter
Dynamic Range	—	93	—	dB	
DAC Output Power	15	—	—	mW	
					32ohm loading

## 2.6 ADC Characteristics

Table 2-6

Parameter	Min	Typ	Max	Unit	Test Conditions
Dynamic Range	—	87	—	dB	1KHz/-60dB 10Kohm loading With A-Weighted Filter
S/N	—	90	—	dB	1KHz/0dB 10Kohm loading With A-Weighted Filter
THD+N	—	-72	—	dB	
Crosstalk	—	-80	—	dB	

## 2.7 WIFI Characteristics

### 2.7.1 Transmitter

Table 2-7-1

Parameter	Date Rate	Min	Typ	Max	Unit	Test Conditions
TX Power (802.11b)	1Mbps	-	19	-	dBm	25°C Power Supply VBAT=3.7V WfVDD33=3.3V 2442MHz 4 Layer Board
	2Mbps	-	19	-	dBm	
	5.5Mbps	-	19	-	dBm	
	11Mbps	-	19	-	dBm	
TX Power (802.11g)	6Mbps	-	19	-	dBm	
	9Mbps	-	19	-	dBm	
	12Mbps	-	19	-	dBm	
	18Mbps	-	19	-	dBm	
	24Mbps	-	18	-	dBm	
	36Mbps	-	17	-	dBm	
	48Mbps	-	16	-	dBm	
	54Mbps	-	15	-	dBm	
TX Power (802.11n, HT20)	MCS0	-	19	-	dBm	
	MCS1	-	19	-	dBm	
	MCS2	-	19	-	dBm	
	MCS3	-	18	-	dBm	
	MCS4	-	17	-	dBm	
	MCS5	-	16	-	dBm	
	MCS6	-	15	-	dBm	
	MCS7	-	14	-	dBm	

Refer to IEEE802.11 specification for TX spectrum limits

### 2.7.2 Receiver

Table 2-7-2

Parameter	Date Rate	Min	Typ	Max	Unit	Test Conditions
RX Sensitivity (802.11b) (8% PER for 1024 octet PSDU)	1Mbps	-	-97	-	dBm	25°C Power Supply VBAT=3.7V WfVDD33=3.3V 2442MHz 4 Layer Board
	2Mbps	-	-95	-	dBm	
	5.5Mbps	-	-93	-	dBm	
	11Mbps	-	-90	-	dBm	
RX Sensitivity (802.11g) (10% PER for 1024 octet PSDU)	6Mbps	-	-92.5	-	dBm	
	9Mbps	-	-91	-	dBm	
	12Mbps	-	-89	-	dBm	
	18Mbps	-	-87	-	dBm	
	24Mbps	-	-84	-	dBm	
	36Mbps	-	-80	-	dBm	

Parameter	Date Rate	Min	Typ	Max	Unit	Test Conditions
	48Mbps	-	-77	-	dBm	25℃ Power Supply VBAT=3.7V WfVDD33=3.3V 2442MHz 4 Layer Board
	54Mbps	-	-75.5	-	dBm	
RX Sensitivity (802.11n,20MHz) (10% PER for 1024 octet PSDU)	MCS0	-	-92.5	-	dBm	
	MCS1	-	-89	-	dBm	
	MCS2	-	-87	-	dBm	
	MCS3	-	-84	-	dBm	
	MCS4	-	-80	-	dBm	
	MCS5	-	-76	-	dBm	
	MCS6	-	-75	-	dBm	
	MCS7	-	-74	-	dBm	
Maximum Receive Level	1Mbps	-	-8	-	dBm	
	11Mbps	-	-8	-	dBm	
	6Mbps	-	-8	-	dBm	
	54Mbps	-	-8	-	dBm	
	MCS0	-	-8	-	dBm	
	MCS7	-	-8	-	dBm	

## 2.8 BT Characteristics

Table 2-8

BT Type	Parameter	Min	Typ	Max	Unit	Test Conditions
BDR	Out Power	-	18	20	dBm	25℃ Power Supply VBAT=3.7V WfVDD33=3.3V 4 Layer Board
	Sensitivity(BER=0.1%)	-	-92	-	dBm	
EDR	Out Power	-	18	18.5	dBm	
	Sensitivity(BER=0.1%)	-	-91	-	dBm	
BLE	Out Power	-	18	19.5	dBm	
	1M Sensitivity(PER=30.8%)	-	-95	-	dBm	
	2M Sensitivity(PER=30.8%)	-	-89	-	dBm	
	Long Range S8 Sensitivity(PER=30.8%)	-	-104	-	dBm	
	Long Range S2 Sensitivity(PER=30.8%)	-	-100	-	dBm	

## 2.9 ESD Protection

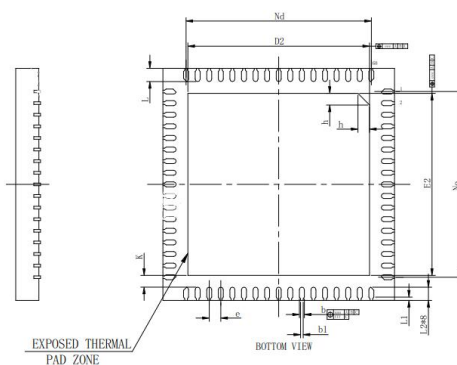
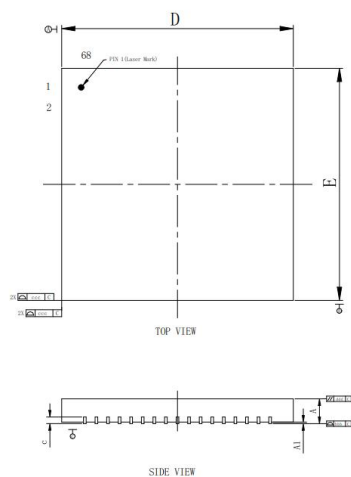
Table 2-9

Parameter	Typ.	Test pin	Reference standard
Human Body Mode	$\pm 4\text{KV}$	All pins(except WFRF )	JEDEC EIA/JESD22-A114
Machine Mode	$\pm 200\text{V}$	All pins	JEDEC EIA/JESD22-A115
Charge Device Model	$\pm 1\text{KV}$	All pins	JEDEC EIA/JESD22-C101F
Latch up	$\pm 200\text{mA}$	All GPIO pins	JEDEC STANDARD NO.78E
	$1.5\times V_{\text{opmax}}$	All power pins	

Note :  $1.5\times V_{\text{opmax}}$  = 1.5 times maximum operating voltage.

## 3. Package Information

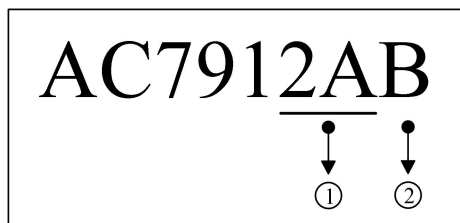
### 3.1 QFN68(7mm\*7mm)



SYMBOL	MILLIMETER		
	MIN	NOM	MAX
A	0.70	0.75	0.80
	0.80	0.85	0.90
	0.85	0.90	0.95
A1	—	0.02	0.05
b	0.10	0.15	0.20
b1	0.08REF		
c	0.18	0.20	0.25
D	6.90	7.00	7.10
D2	5.39	5.49	5.59
e	0.35BSC		
Nd	5.60BSC		
E	6.90	7.00	7.10
E2	5.39	5.49	5.59
Ne	5.60BSC		
L	0.35	0.40	0.45
L1	0.10REF		
L2	0.30	0.40	0.50
K	0.20	—	—
h	0.30	0.35	0.40
aaa	0.07		
bbb	0.08		
ccc	0.10		
ddd	0.10		
eee	0.10		
fff	0.05		

Figure 3-1 AC7912A\_QFN68 Package

## 4. Package Type Specification



①Represents different chips (different packages or bindings)

②Represents different memory sizes

0: No memory

2: 2Mbit Flash

4: 4Mbit Flash

8: 8Mbit Flash

6: 16Mbit Flash

3: 32Mbit Flash

5: 64Mbit Flash

7: 128Mbit Flash

A: 1Mx16 SDRAM

B: 4Mx16 SDRAM

C: 16M bit PSRAM

D: 64M bit PSRAM

## 5. Solder-Reflow Condition

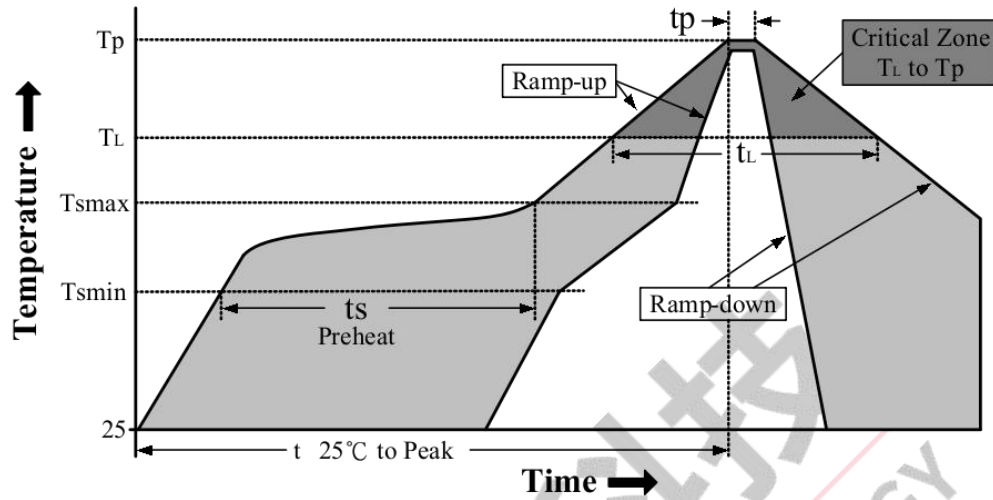


Figure 5-1 Classification Reflow Profile

### Classification Profiles

Table 5-1

Profile Feature		Sn-Pb Eutectic Assembly	Pb-Free Assembly
Preheat/Soak	Temperature Min ( $T_{smin}$ )	100°C	150°C
	Temperature Max ( $T_{smax}$ )	150°C	200°C
	Time ( $t_s$ ) from ( $T_{smin}$ to $T_{smax}$ )	60-120 seconds	60-180 seconds
Average ramp-up rate ( $T_{smax}$ to $T_p$ )		3°C/second max	3°C/second max
Liquidous temperature ( $T_L$ )		183°C	217°C
Time ( $t_L$ ) maintained above $T_L$		60-150 seconds	60-150 seconds
Peak package body temperature ( $T_p$ )		See Table 6-2	See Table 6-3
Time within 5°C of actual Peak Temperature ( $t_p$ ) <sup>2</sup>		10-30 seconds	20-40 seconds
Ramp-down rate ( $T_p$ to $T_L$ )		6°C/second max	6°C/second max
Time 25°C to peak temperature		6 minutes max	8 minutes max

Note 1: All temperatures refer to topside of the package, measured on the package body surface.

Note 2: Time within 5°C of actual peak temperature ( $t_p$ ) specified for the reflow profiles is a “supplier” minimum and “user” maximum.

### SnPb - Classification Temperature

Table 5-2

Package Thickness	Volume mm <sup>3</sup> < 350	Volume mm <sup>3</sup> ≥ 350
<2.5 mm	240 +0/-5°C	225 +0/-5°C
≥2.5 mm	225 +0/-5°C	225 +0/-5°C

**Pb-free - Classification Temperature**      **Table 5-3**

Package Thickness	Volume mm <sup>3</sup> < 350	Volume mm <sup>3</sup> 350 - 2000	Volume mm <sup>3</sup> > 2000
< 1.6mm	260℃	260℃	260℃
1.6 mm - 2.5mm	260℃	250℃	245℃
> 2.5mm	250℃	245℃	245℃



## 6. Revision History

Date	Revision	Description
2022.06.06	V1.0	Initial release
2022.08.04	V1.1	Updated parameter